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NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

VQFN-HR - 1 mm max height

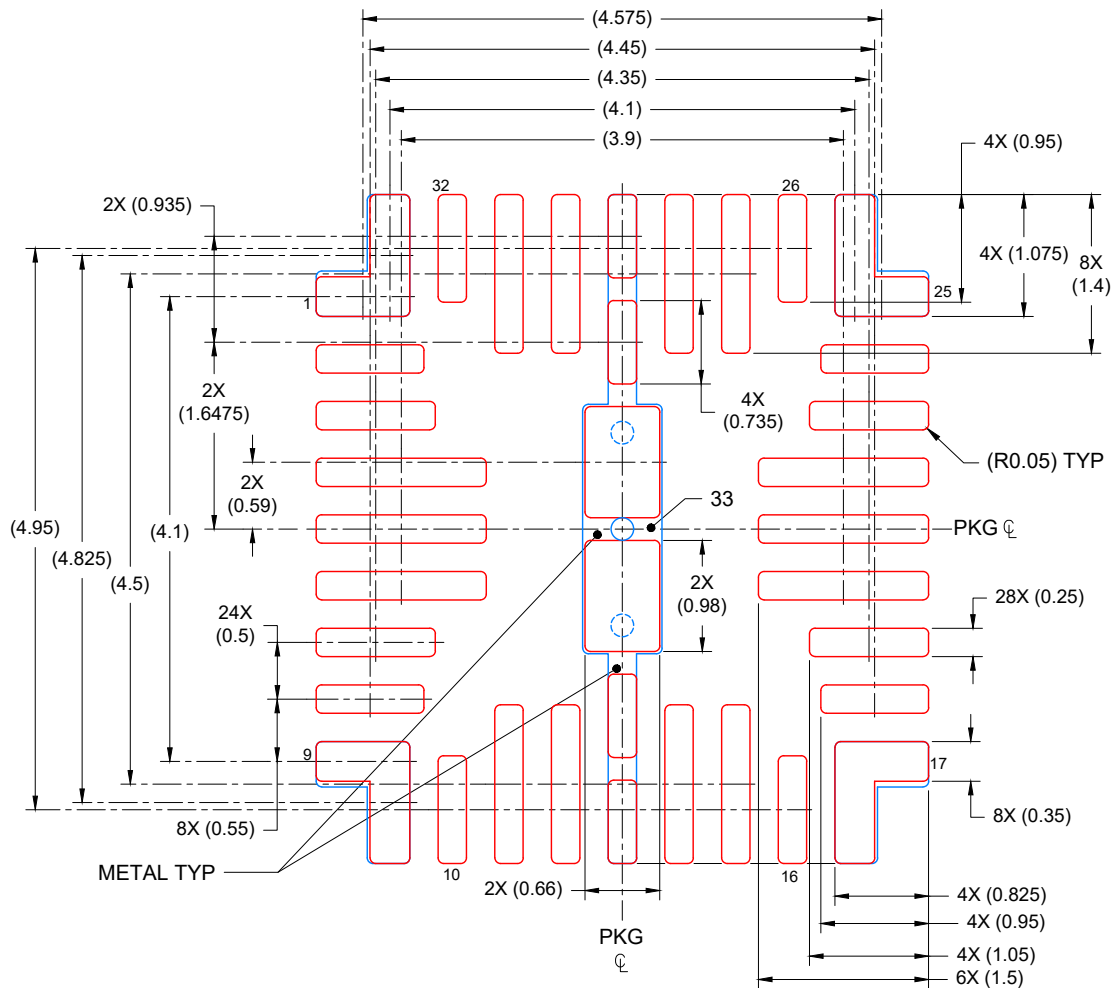
[illegible]

The diagram illustrates two PCB manufacturing approaches for a rectangular pad:

- Non-Solder Mask Defined (Preferred):** This method shows a rectangular pad of metal (blue) with a solder mask opening (green outline). The dimensions are specified as 0.05 MAX ALL AROUND. Labels include: METAL, SOLDER MASK OPENING, EXPOSED METAL, and NON-SOLDER MASK DEFINED (PREFERRED).
- Solder Mask Defined:** This method shows a rectangular pad of metal (blue) with a solder mask opening (green outline). The dimensions are specified as 0.05 MIN ALL AROUND. Labels include: SOLDER MASK OPENING, METAL UNDER SOLDER MASK, EXPOSED METAL, and SOLDER MASK DEFINED.

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3. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
4. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE
BASED ON 0.1mm THICK STENCIL

PIN 1,9,16 & 25: 93%; PIN 13& 29: 79%; PIN 33: 84%
 SCALE: 15X

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NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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